

RJK0328DPB

Silicon N Channel Power MOS FET Power Switching

REJ03G1637-0400 Rev.4.00 Apr 10, 2008

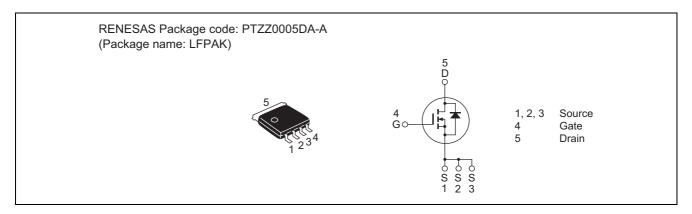
Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 1.6 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$

• Pb-free

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	60	А
Drain peak current	I _{D(pulse)} Note1	240	А
Body-drain diode reverse drain current	I _{DR}	60	А
Avalanche current	I _{AP} Note 2	30	А
Avalanche energy	E _{AR} Note 2	90	mJ
Channel dissipation	Pch Note3	65	W
Channel to Case Thermal Resistance	θch-C	1.93	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \geq 50 Ω

3. Tc = 25°C

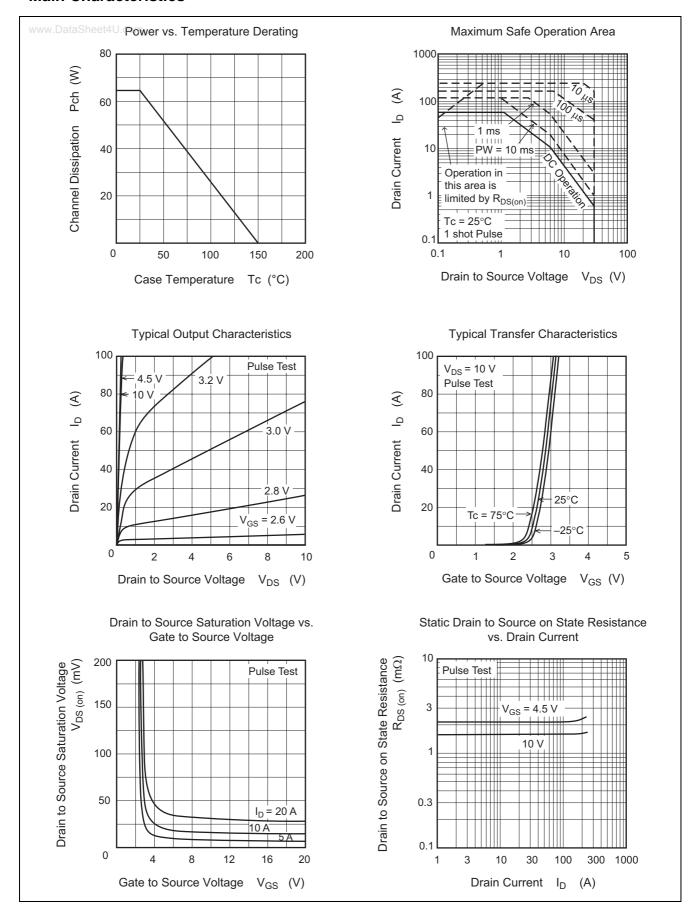
Electrical Characteristics

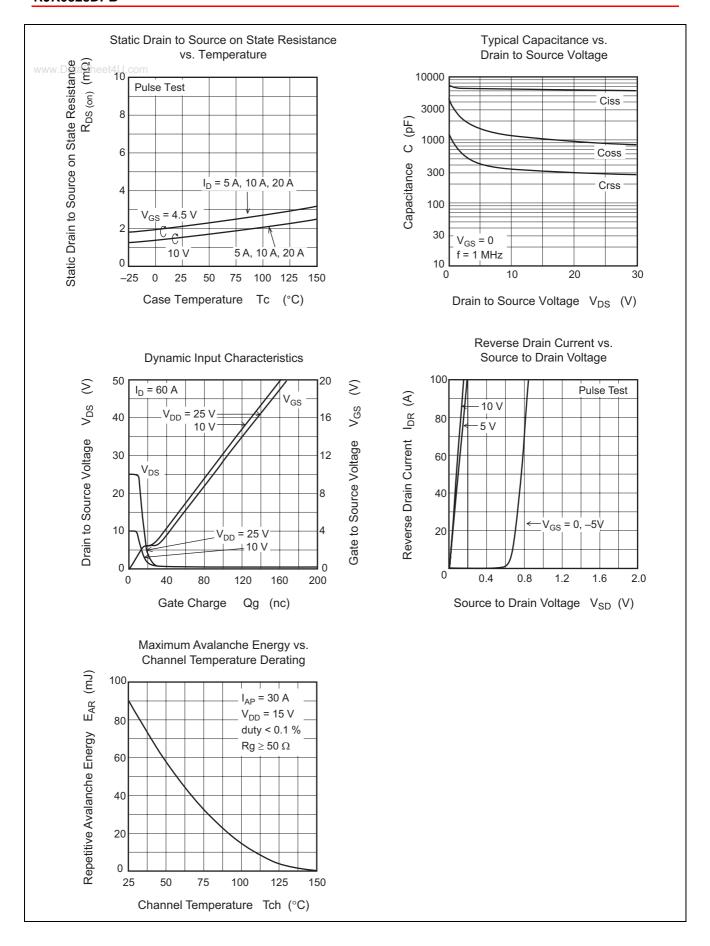
 $(Ta = 25^{\circ}C)$

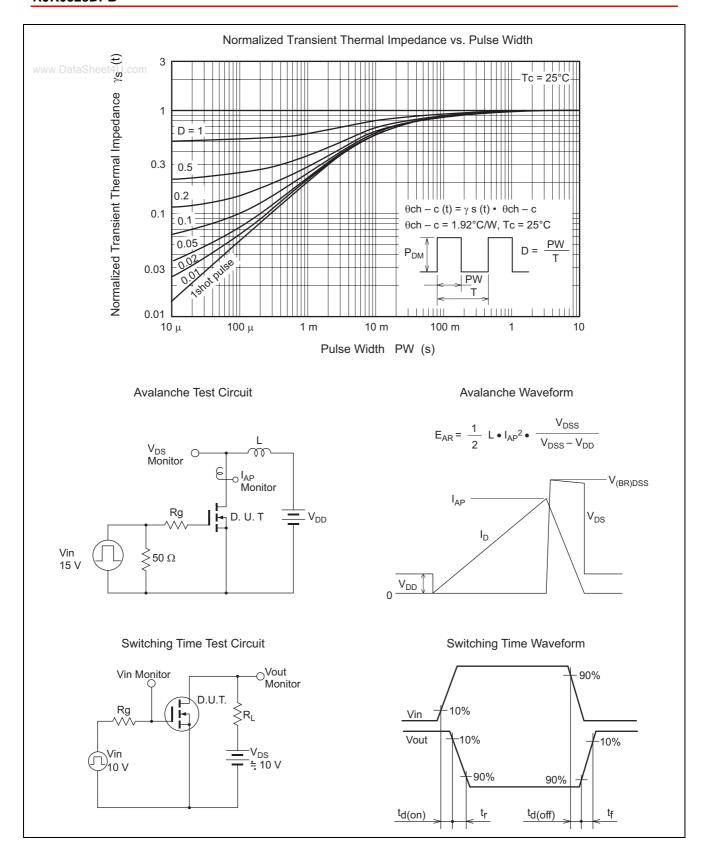
www.DataSheet4itemm	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}		_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	1	1.6	2.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	2.1	2.9	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	1	100	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	1	6380	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	1150	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	330	_	pF	
Gate Resistance	Rg	_	0.7	_	Ω	
Total gate charge	Qg	_	42	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs	_	15	_	nC	I _D = 60 A
Gate to drain charge	Qgd	_	8.8	_	nC	
Turn-on delay time	t _{d(on)}	_	9.4	_	ns	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A},$
Rise time	t _r	_	4.3	_	ns	$V_{DD} \cong 10 \text{ V}, R_L = 0.33 \Omega,$
Turn-off delay time	$t_{d(off)}$	_	61.5	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	7.3	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.78	1.02	V	$I_F = 60 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body–drain diode reverse recovery time	t _{rr}	_	42	_	ns	$I_F = 60 \text{ A}, V_{GS} = 0$ $di_F / dt = 100 \text{ A} / \mu \text{s}$
Body-drain diode reverse recovery charge	Q _{rr}		46	_	nC	

Notes: 4. Pulse test

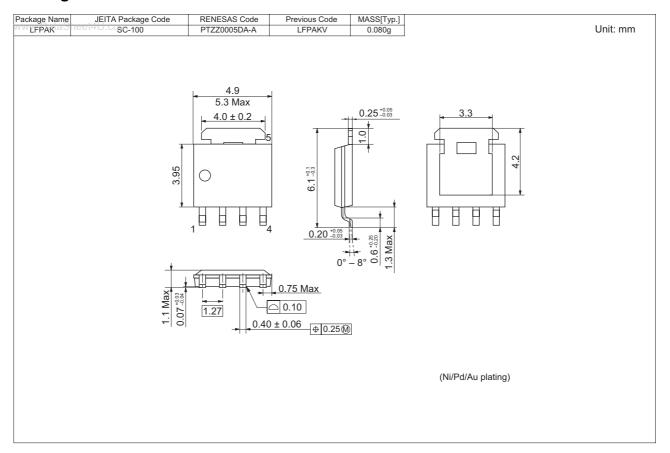
Main Characteristics







Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK0328DPB-00-J0	2500 pcs	Taping

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